PCN Number:	<b>CN Number:</b> 20180810000		PCN Date: August 1			st 13,	3, 2018	
Title: Datasheet for OPA837,OPA2837								
Customer Contact:	PCN Manager				De	pt:	Quality Services	
Change Type:								
Assembly Site		Desig	IN			Wafe	r Bump Site	
Assembly Process		🛛 Data Sheet					r Bump Material	
Assembly Materials		Part number change					r Bump Process	
Mechanical Specification		Test Site				r Fab Site		
Packing/Shipping/Labeling		Test Process					Fab Materials	
						Wafe	- Fab Process	
Notification Details								
<b>Description of Change:</b> Texas Instruments Incorporated is announcing an information only notification.								
The product datasheet(s) is being updated as summarized below. The following change history provides further details.								
INSTRUMENTS					CROCETS		OPA837, OPA2837 MBER 2017-REVISED JULY 2018	
Changes from Revision A	(April 2018) to Rev	ision B			5005673	D-SEPTE	Page	
Changed input common-	mode impedance in	5V and	3V electrical char	acteristic	s table	s		
The datasheet number	will be changing	na.						
Device Family			Change From:			Change To:		
OPA837,OPA2837			SBOS673A S			SBOS673B		
These changes may be reviewed at the datasheet links provided.								
http://www.ti.com/product/OPA2837								
Reason for Change:								
To accurately reflect device characteristics.								
Anticipated impact of	on Fit, Form, F	unctio	n, Quality o	r Relia	bility	(pos	itive / negative):	
No anticipated impact. to the actual device.	This is a specif	ication	change anno	uncem	ent o	nly. Th	ere are no changes	
Changes to product identification resulting from this PCN:								
None.								
Product Affected:								
OPA2837IDGKR	OPA2837IDGKT		OPA283	OPA2837IRUNR		0	PA2837IRUNT	
OPA837IDBVR	OPA837IDB			OPA837IDCKR			PA837IDCKT	
For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.								

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com